



# ***UNDP-1 Lenovo T400 SAR Report***

***80-VH688-3 Rev. A***

***February 8, 2008***

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## 12. Photos of test setup

### 12.1 Photos of DUT

Figure 12-1 External View of Notebook (closed)

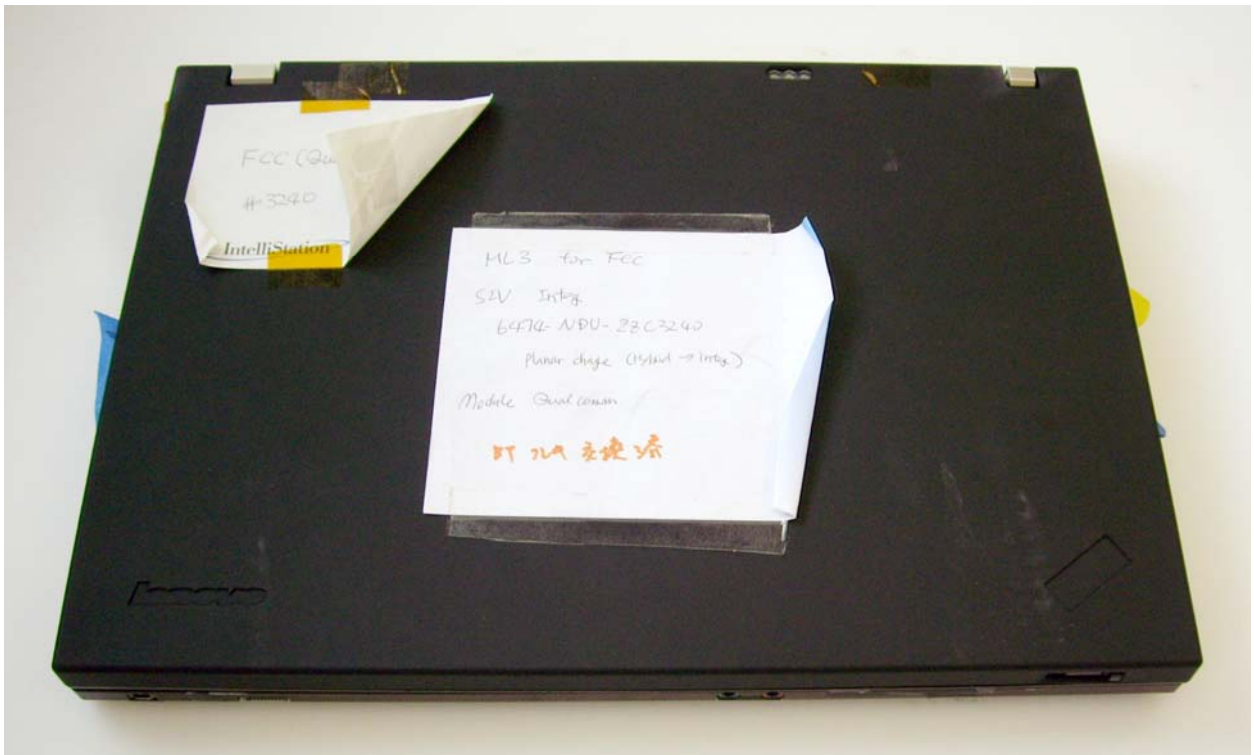


Figure 12-2 External View of Notebook (open)



Figure 12-3 Internal View of Notebook with Module Exposed

